

COMMON MODE FILTER CHOKE-JACM 4532 SERIES

Reliability and Test Condition

Item	Performance	Test Condition		
Electrical Performance Test				
Z(common mode)		Agilent-4291A+ Agilent -16197A		
DCR	Refer to standard electrical characteristics list.	Agilent-4338B		
I.R.	51414507154155 11541	Agilent-4339		
Operating Temperature	-40°C ~+150°C (Including self - temperature rise)			
Storage Temperature	-40°C ~+125°C (on board)			
Temperature Rise Test	Rated Current ∆T 40°C Max	1.Applied the allowed DC current.		
		2.Temperature measured by digital surface thermometer		
Reliability Test				
Life Test	Appearance: No damage Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning:Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles) Temperature: 150±2°C Applied current: rated current Duration: 1000±12hrs Measured at room temperature after placing for 24±2 hrs		
Load Humidity	Appearance: No damage Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning:Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles) Temperature: 85±2% R.H Temperature: 85°C±2°C Duration: 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24±2 hrs		
Moisture Resistance	Appearance: No damage Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning:Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles) 1. Baked at50°C for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 3. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs, keep at 25°C for 2 hrs then keep at -10°C for 3 hrs 4. Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.		
Thermal shock	Appearance: No damage Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning:Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles) Condition for 1 cycle Step1: $-40\pm2^{\circ}\mathbb{C}$ 30 \pm 5min Step2: $25\pm2^{\circ}\mathbb{C} \le 0.5$ min Step3: $150\pm2^{\circ}\mathbb{C}$ 30 \pm 5min Number of cycles: 500 Measured at room temperature after placing for 24 \pm 2 hrs		
Vibration	Appearance: No damage Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not exceed the specification value	Oscillation Frequency: 10Hz~2KHz~10Hz for 20 minutes Equipment: Vibration checker Total Amplitude:10g Testing Time: 12 hours (20 minutes, 12 cycles each of 3 orientations)		

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Bending	Appearance: No damage Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not exceed the specification value	Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.		
Shock	Appearance: No damage Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not exceed the specification value	Type Peak value duration (D) form change (Vi)ft/sec SMD 50 11 Half-sine 11.3 Lead 50 11 Half-sine 11.3		
Solder ability	More than 95% of the terminal electrode should be covered with solder	Preheat: 150°C,60sec. Solder: Sn96.5% Ag3% Cu0.5% Temperature: 245±5°C Flux for lead free: Rosin. 9.5% Dip time: 4±1sec Depth: completely cover the termination		
Resistance to Soldering Heat	Appearance: No damage Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not exceed the specification value	Depth: completely cover the termination Temperature ramp/immersion and emersion rate 260 ±5 (solder temp) 10 ±1 25mm/s ±6 mm/s 1		
Terminal Strength	Appearance: No damage Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning:Run through IR reflow for 2 times. (IPC/JEDEC J-STD-020DClassification Reflow Profiles) With the component mounted on a PCB with the device to be tested, apply a force(>0805:1kg, <=0805:0.5kg)to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.		

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Soldering and Mou	unting		
Soldering	Mildly activated rosin fluxes are preferred. JANTEK terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.		
Solder re-flow:	Recommended temperature profiles for re-flow soldering in Figure 1.		
Soldering Iron (Figure 2):	Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. Note: • Preheat circuit and products to 150°C • Never contact the ceramic with the iron tip • Use a 20 watt soldering iron with tip diameter of 1.0mm • 350°C tip temperature (max) • 1.0mm tip diameter (max) • Limit soldering time to 4~5 sec		



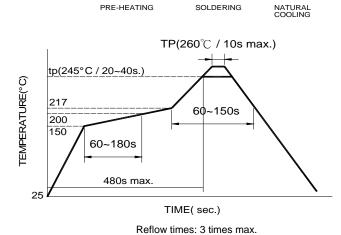


Fig.1

Iron Soldering times: 1 times max.

Iron Soldering

Fig.2

